

To our customers,

Old Company Name in Catalogs and Other Documents

On April 1st, 2010, NEC Electronics Corporation merged with Renesas Technology Corporation, and Renesas Electronics Corporation took over all the business of both companies. Therefore, although the old company name remains in this document, it is a valid Renesas Electronics document. We appreciate your understanding.

Renesas Electronics website: <http://www.renesas.com>

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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PHOTOCOUPLER PS9213

**1 Mbps, OPEN COLLECTOR OUTPUT
HIGH CMR, INTELLIGENT POWER MODULE
5-PIN SOP PHOTOCOUPLER
FOR CREEPAGE DISTANCE OF 5.5 mm**

–NEPOC Series–

DESCRIPTION

The PS9213 is an optically coupled isolator containing a GaAlAs LED on the input side and a photo diode and a signal processing circuit on the output side on one chip.

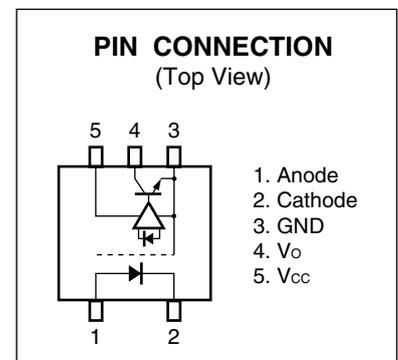
The PS9213 is designed specifically for high common mode transient immunity (CMR) and low pulse width distortion with operating temperature. It is suitable for IPM drive.

FEATURES

- Long creepage distance (5.5 mm MIN.)
- High common mode transient immunity ($CM_H, CM_L = \pm 15 \text{ kV}/\mu\text{s}$ MIN.)
- High-speed response ($t_{PHL} = 500 \text{ ns}$ MAX., $t_{PLH} = 750 \text{ ns}$ MAX.)
- Maximum propagation delays ($t_{PLH} - t_{PHL} = 270 \text{ ns}$ TYP.)
- Pulse width distortion ($|t_{PHL} - t_{PLH}| = 270 \text{ ns}$ TYP.)
- Ordering number of taping product: PS9213-F3, F4: 2 500 pcs/reel
- Pb-Free product
- Safety standards
 - UL approved: File No. E72422
 - DIN EN60747-5-2 (VDE0884 Part2) approved No.40008347 (Option)

APPLICATIONS

- IPM Driver
- General purpose inverter

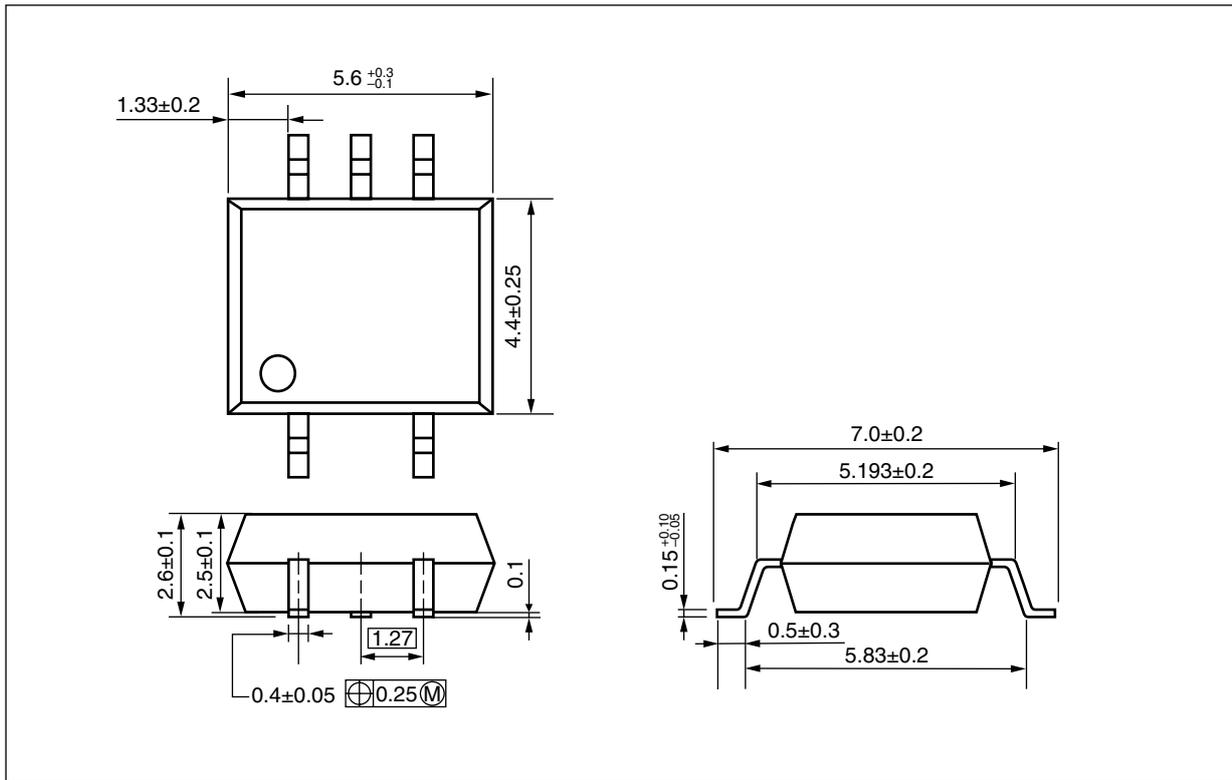


TRUTH TABLE

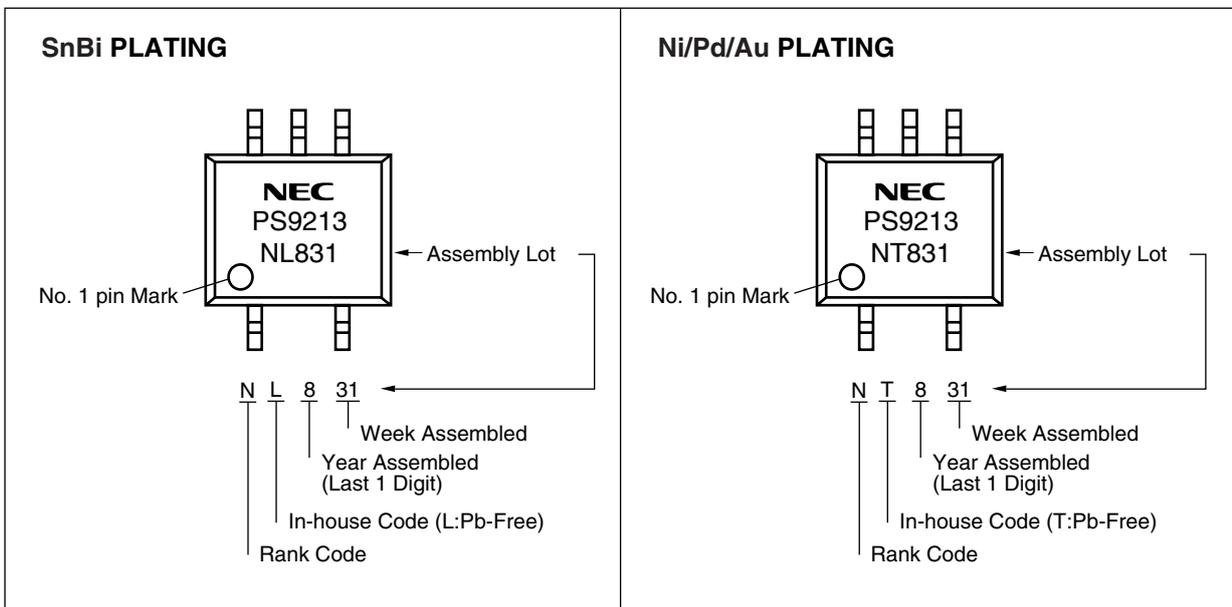
| LED | Output |
|-----|--------|
| ON | L |
| OFF | H |

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PACKAGE DIMENSIONS (UNIT: mm)



<R> MARKING EXAMPLE



<R> ORDERING INFORMATION

| Part Number | Order Number | Solder Plating Specification | Packing Style | Safety Standard Approval | Application Part Number ^{*1} |
|-------------|----------------|------------------------------|------------------------------|---|---------------------------------------|
| PS9213 | PS9213-A | Pb-Free (SnBi) | 20 pcs (Tape 20 pcs cut) | Standard products (UL approved) | PS9213 |
| PS9213-F3 | PS9213-F3-A | | Embossed Tape 2 500 pcs/reel | | |
| PS9213-F4 | PS9213-F4-A | | | | |
| PS9213-V | PS9213-V-A | | 20 pcs (Tape 20 pcs cut) | DIN EN60747-5-2 (VDE0884 Part2) approved (Option) | |
| PS9213-V-F3 | PS9213-V-F3-A | | Embossed Tape 2 500 pcs/reel | | |
| PS9213-V-F4 | PS9213-V-F4-A | | | | |
| PS9213 | PS9213-AX | Pb-Free (Ni/Pd/Au) | 20 pcs (Tape 20 pcs cut) | Standard products (UL approved) | |
| PS9213-F3 | PS9213-F3-AX | | Embossed Tape 2 500 pcs/reel | | |
| PS9213-F4 | PS9213-F4-AX | | | | |
| PS9213-V | PS9213-V-AX | | 20 pcs (Tape 20 pcs cut) | DIN EN60747-5-2 (VDE0884 Part2) approved (Option) | |
| PS9213-V-F3 | PS9213-V-F3-AX | | Embossed Tape 2 500 pcs/reel | | |
| PS9213-V-F4 | PS9213-V-F4-AX | | | | |

*1 For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, unless otherwise specified)

| Parameter | | Symbol | Ratings | Unit |
|--------------------------------|--------------------------------|------------------|-------------|---------|
| Diode | Forward Current ¹ | I _F | 25 | mA |
| | Reverse Voltage | V _R | 5 | V |
| Detector | Supply Voltage | V _{CC} | -0.5 to +35 | V |
| | Output Voltage | V _O | -0.5 to +35 | V |
| | Output Current | I _O | 15 | mA |
| | Power Dissipation ² | P _C | 100 | mW |
| Isolation Voltage ³ | | BV | 2 500 | Vr.m.s. |
| Operating Ambient Temperature | | T _A | -40 to +100 | °C |
| Storage Temperature | | T _{stg} | -55 to +125 | °C |

*1 Reduced to 0.33 mA/°C at T_A = 70°C or more.

*2 Reduced to 1.9 mW/°C at T_A = 70°C or more.

*3 AC voltage for 1 minute at T_A = 25°C, RH = 60% between input and output.
Pins 1-2 shorted together, 3-5 shorted together.

RECOMMENDED OPERATING CONDITIONS

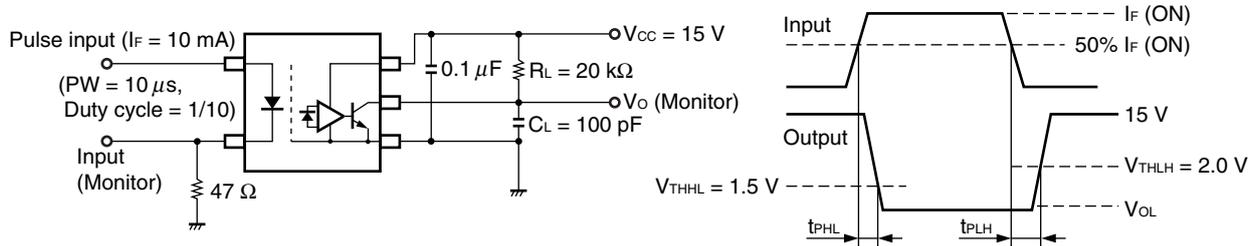
| Parameter | Symbol | MIN. | TYP. | MAX. | Unit |
|--------------------------|-----------------|------|------|------|------|
| High Level Input Current | I _{FH} | 10 | | 20 | mA |
| Output Voltage | V _O | 0 | | 30 | V |
| Supply Voltage | V _{CC} | 4.5 | 15 | 30 | V |
| LED Off Voltage | V _F | 0 | | 0.8 | V |

ELECTRICAL CHARACTERISTICS (T_A = -40 to +100°C, V_{CC} = 15 V, unless otherwise specified)

| Parameter | | Symbol | Conditions | MIN. | TYP. ¹⁾ | MAX. | Unit |
|--|---|--|--|---|--------------------|-------|------|
| Diode | Forward Voltage | V _F | I _F = 10 mA | 1.3 | 1.65 | 2.1 | V |
| | Reverse Current | I _R | V _R = 3 V | | | 200 | μA |
| | Terminal Capacitance | C _t | V = 0 V, f = 1 MHz, T _A = 25°C | | 30 | | pF |
| Detector | Low Level Output Voltage | V _{OL} | I _F = 10 mA, I _{OL} = 2.4 mA | | 0.13 | 0.6 | V |
| | High Level Output Current | I _{OH} | V _{CC} = V _O = 30 V, V _F = 0.8 V | | 0.01 | 50 | μA |
| | High Level Supply Current | I _{COH} | V _{CC} = 30 V, V _F = 0.8 V, V _O = open | | 0.6 | 1.3 | mA |
| | Low Level Supply Current | I _{COL} | V _{CC} = 30 V, I _F = 10 mA, V _O = open | | 0.6 | 1.3 | mA |
| Coupled | Threshold Input Current (H → L) | I _{FHL} | V _O = 0.8 V, I _O = 0.75 mA | | 1.5 | 5.0 | mA |
| | Current Transfer Ratio (I _C /I _F) | CTR | I _F = 10 mA, V _O = 0.6 V | 44 | 110 | | % |
| | Isolation Resistance | R _{I-O} | V _{I-O} = 1 kV _{DC} , R _H = 40 to 60%, T _A = 25°C | 10 ¹¹ | | | Ω |
| | Isolation Capacitance | C _{I-O} | V _{I-O} = 0 V, f = 1 MHz, T _A = 25°C | | 0.6 | | pF |
| | Propagation Delay Time (H → L) ²⁾ | t _{PHL} | I _F = 10mA, R _L = 20 kΩ, C _L = 100 pF, V _{THHL} = 1.5 V, V _{THLH} = 2.0 V | | 250 | 500 | ns |
| | Propagation Delay Time (L → H) ²⁾ | t _{PLH} | | | 520 | 750 | |
| | Maximum Propagation Delays | t _{PLH} -t _{PHL} | | -200 | 270 | 650 | |
| | Pulse Width Distortion (PWD) ²⁾ | t _{PHL} -t _{PLH} | | | 270 | 650 | |
| | Common Mode Transient Immunity at High Level Output ³⁾ | CM _H | | T _A = 25°C, I _F = 0 mA, V _O > 3.0 V, V _{CM} = 1.5 kV, R _L = 20 kΩ, C _L = 100 pF | 15 | | |
| Common Mode Transient Immunity at Low Level Output ³⁾ | CM _L | T _A = 25°C, I _F = 10 mA, V _O < 1.0 V, V _{CM} = 1.5 kV, R _L = 20 kΩ, C _L = 100 pF | 15 | | | kV/μs | |

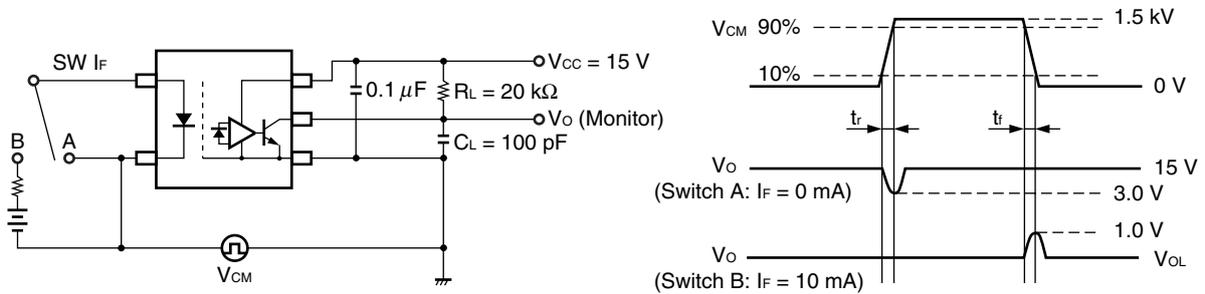
*1 Typical values at $T_A = 25^\circ\text{C}$.

*2 Test circuit for propagation delay time



Remark C_L includes probe and stray wiring capacitance.

*3 Test circuit for common mode transient immunity

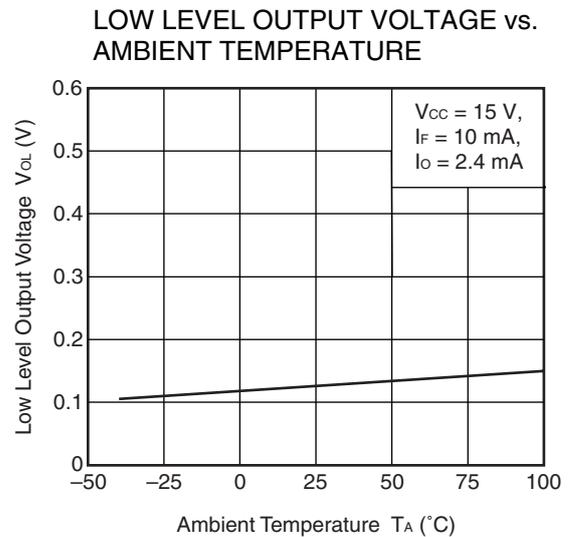
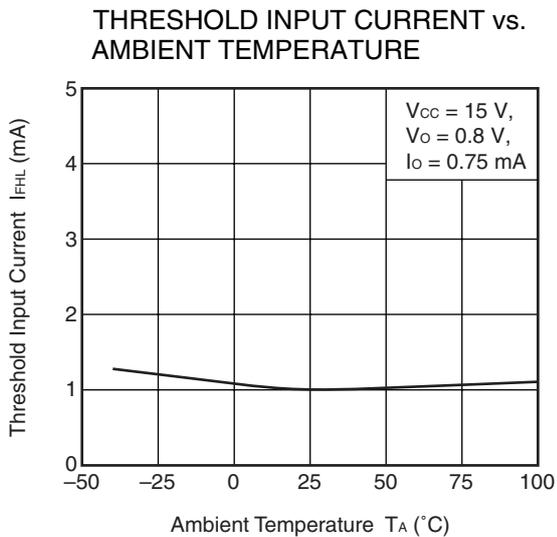
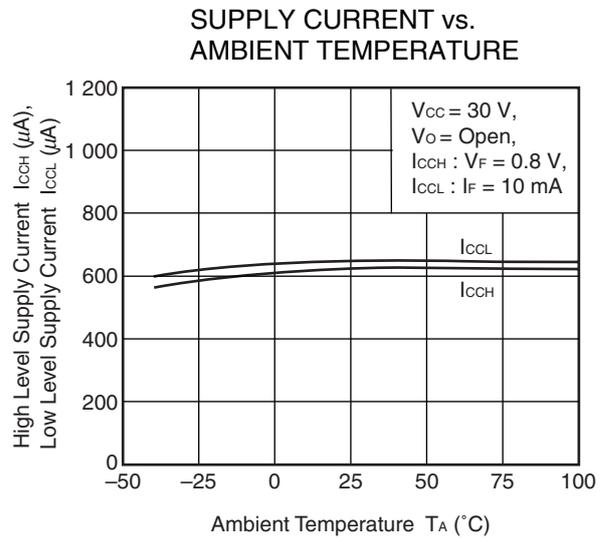
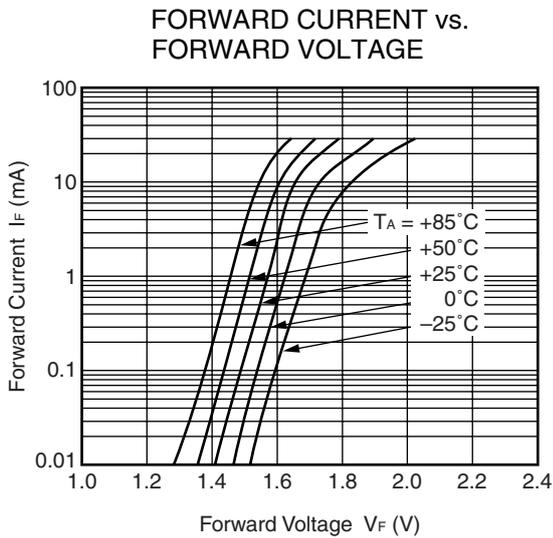
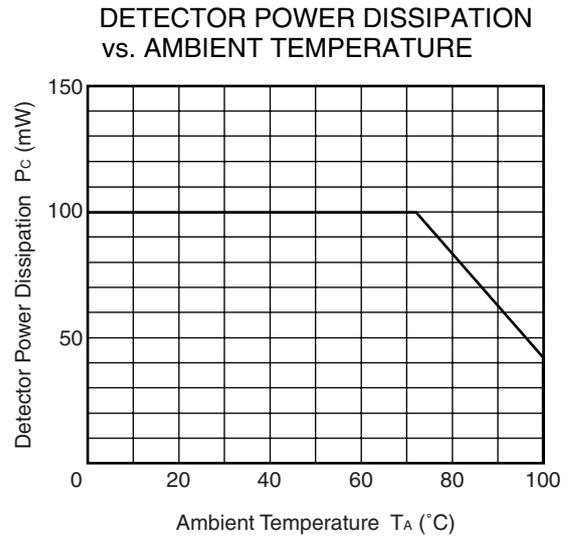
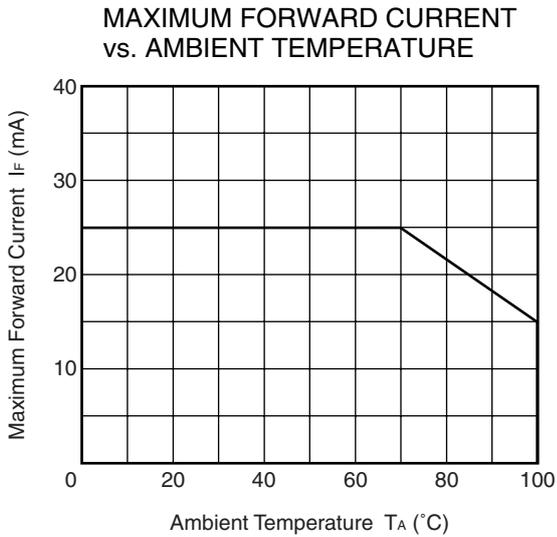


Remark C_L includes probe and stray wiring capacitance.

USAGE CAUTIONS

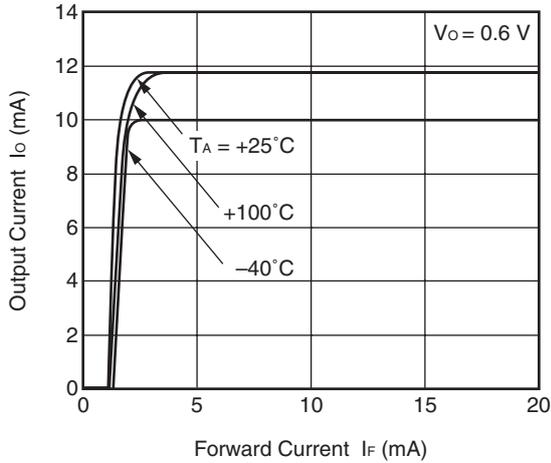
1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
2. By-pass capacitor of $0.1 \mu\text{F}$ is used between V_{CC} and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is no more than 10 mm.
3. Avoid storage at a high temperature and high humidity.

TYPICAL CHARACTERISTICS (T_A = 25°C unless otherwise specified)

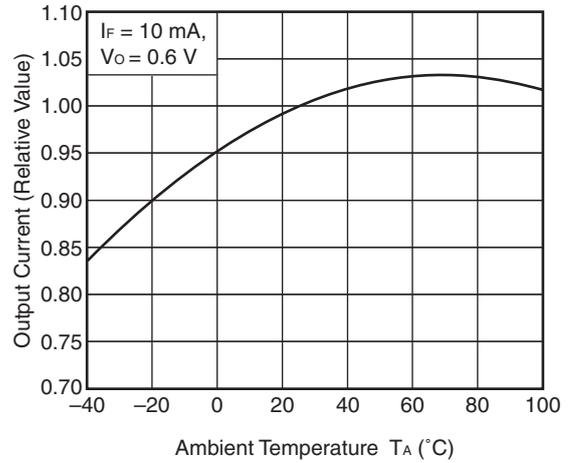


Remark The graphs indicate nominal characteristics.

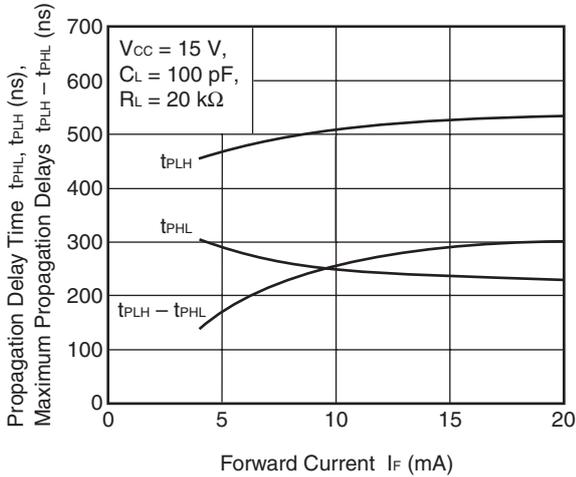
OUTPUT CURRENT vs. FORWARD CURRENT



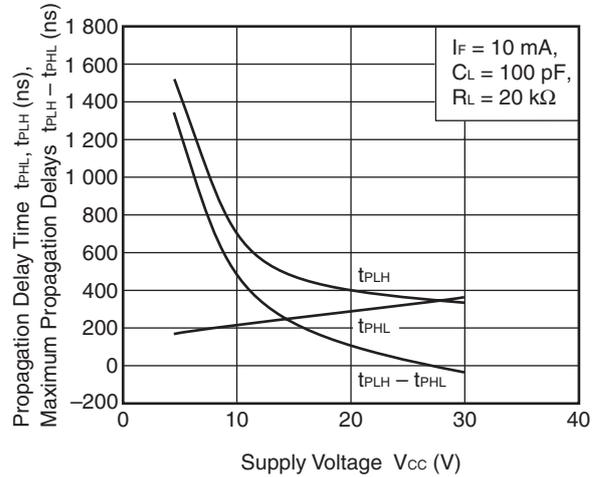
OUTPUT CURRENT vs. AMBIENT TEMPERATURE



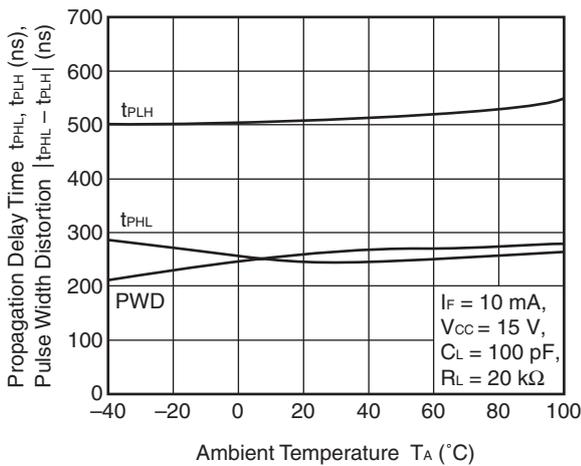
PROPAGATION DELAY TIME, MAXIMUM PROPAGATION DELAYS vs. FORWARD CURRENT



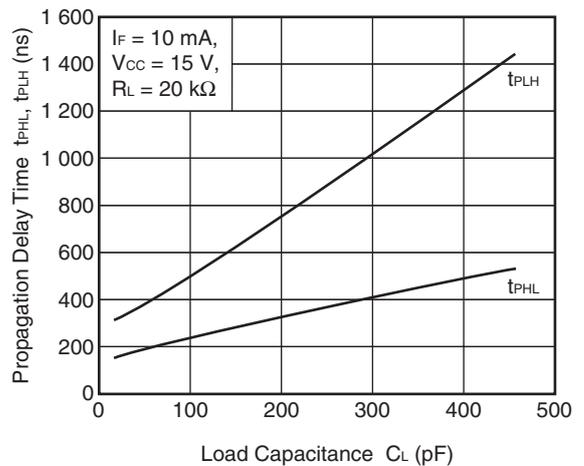
PROPAGATION DELAY TIME, MAXIMUM PROPAGATION DELAYS vs. SUPPLY VOLTAGE



PROPAGATION DELAY TIME, PULSE WIDTH DISTORTION vs. AMBIENT TEMPERATURE

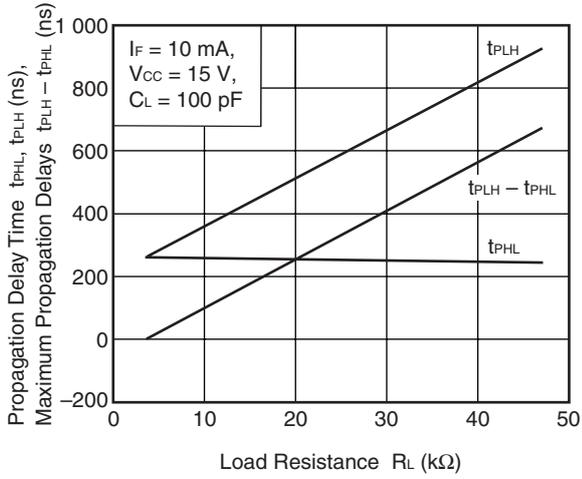


PROPAGATION DELAY TIME vs. LOAD CAPACITANCE

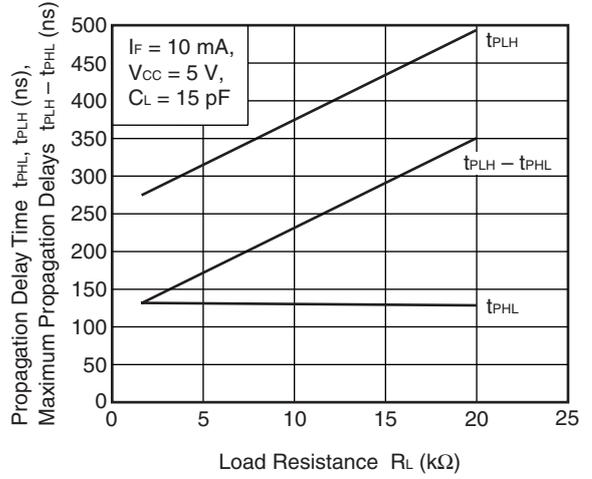


Remark The graphs indicate nominal characteristics.

PROPAGATION DELAY TIME,
MAXIMUM PROPAGATION DELAYS
vs. LOAD RESISTANCE



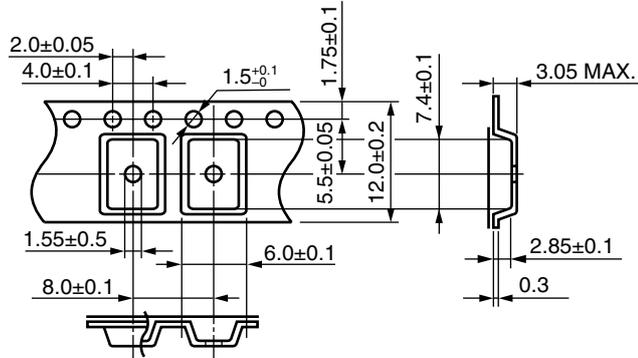
PROPAGATION DELAY TIME,
MAXIMUM PROPAGATION DELAYS
vs. LOAD RESISTANCE



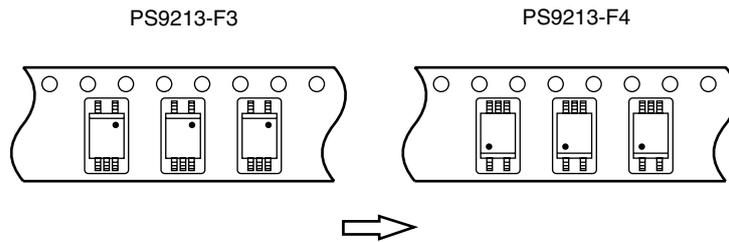
Remark The graphs indicate nominal characteristics.

TAPING SPECIFICATIONS (UNIT: mm)

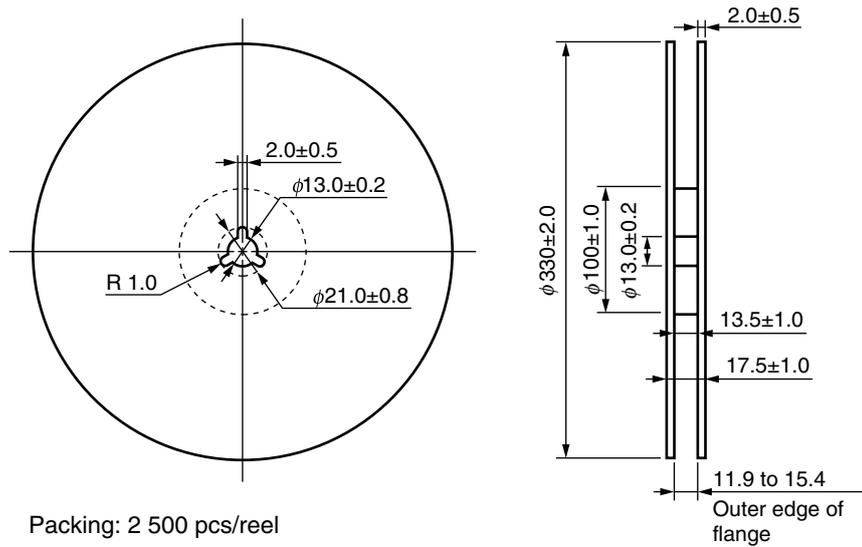
Outline and Dimensions (Tape)



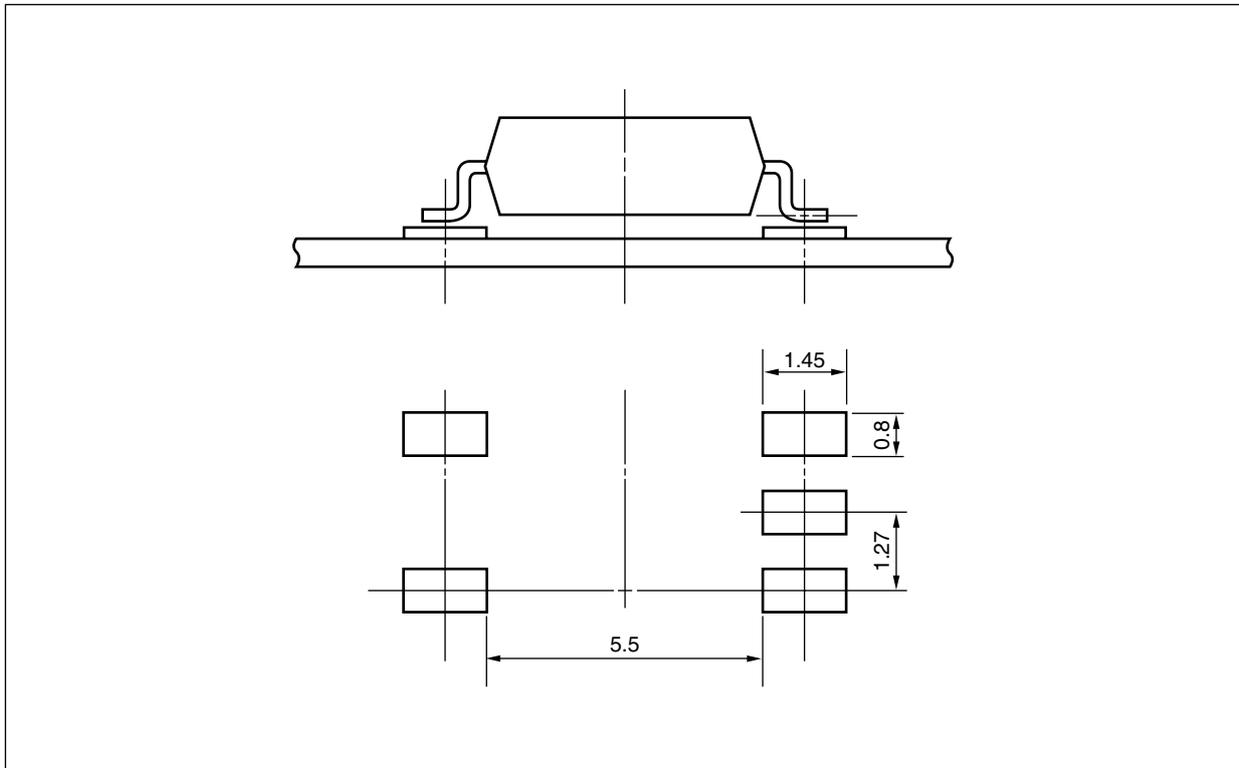
Tape Direction



Outline and Dimensions (Reel)



RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)



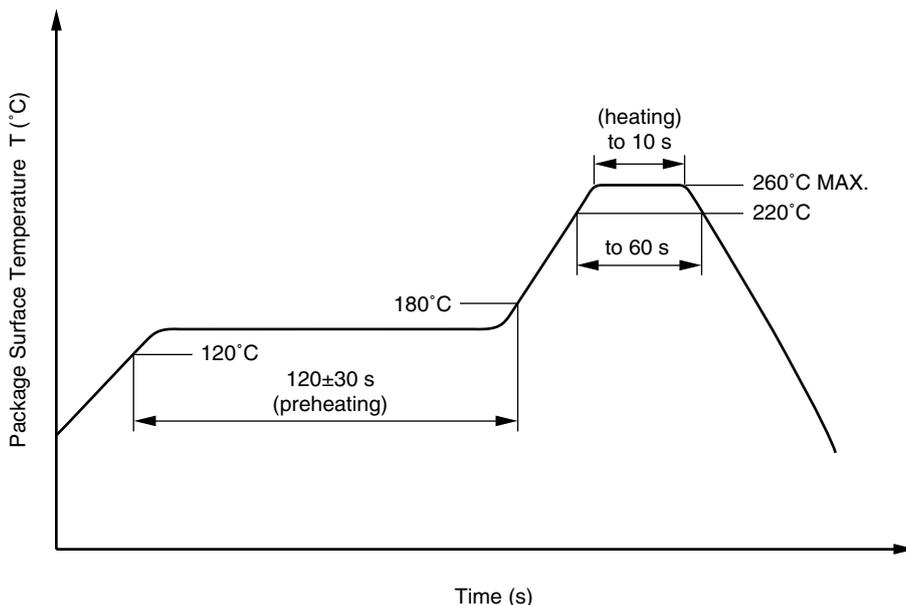
NOTES ON HANDLING

1. Recommended soldering conditions

(1) Infrared reflow soldering

- Peak reflow temperature 260°C or below (package surface temperature)
- Time of peak reflow temperature 10 seconds or less
- Time of temperature higher than 220°C 60 seconds or less
- Time to preheat temperature from 120 to 180°C 120±30 s
- Number of reflows Three
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



(2) Wave soldering

- Temperature 260°C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times One (Allowed to be dipped in solder including plastic mold portion.)
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(3) Soldering by Soldering Iron

- Peak Temperature (lead part temperature) 350°C or below
- Time (each pins) 3 seconds or less
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

- (a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead
- (b) Please be sure that the temperature of the package would not be heated over 100°C

(4) Cautions

- Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

USAGE CAUTIONS

1. Protect against static electricity when handling.
2. Avoid storage at a high temperature and high humidity.

<R> SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

| Parameter | Symbol | Speck | Unit |
|---|---|-----------------------------|----------------------------|
| Application classification (DIN EN 60664-1 VDE0110 Part 1) for rated line voltages ≤ 300 Vr.m.s. for rated line voltages ≤ 600 Vr.m.s. | | IV III | |
| Climatic test class (DIN EN 60664-1 VDE0110) | | 40/100/21 | |
| Dielectric strength maximum operating isolation voltage Test voltage (partial discharge test, procedure a for type test and random test) $U_{pr} = 1.5 \times U_{IORM}, P_d < 5 \text{ pC}$ | U_{IORM} U_{pr} | 707 1 061 | V_{peak} V_{peak} |
| Test voltage (partial discharge test, procedure b for all devices) $U_{pr} = 1.875 \times U_{IORM}, P_d < 5 \text{ pC}$ | U_{pr} | 1 326 | V_{peak} |
| Highest permissible overvoltage | U_{TR} | 6 000 | V_{peak} |
| Degree of pollution (DIN EN 60664-1 VDE0110 Part 1) | | 2 | |
| Clearance distance | | >4.0 | mm |
| Creepage distance | | >4.0 | mm |
| Comparative tracking index (DIN IEC 112/VDE 0303 Part 1) | CTI | 175 | |
| Material group (DIN EN 60664-1 VDE0110 Part 1) | | III a | |
| Storage temperature range | T_{stg} | -55 to +125 | °C |
| Operating temperature range | T_A | -40 to +100 | °C |
| Isolation resistance, minimum value $V_{IO} = 500 \text{ V dc at } T_A = 25^\circ\text{C}$ $V_{IO} = 500 \text{ V dc at } T_A \text{ MAX. at least } 100^\circ\text{C}$ | $R_{is \text{ MIN.}}$ $R_{is \text{ MIN.}}$ | 10^{12} 10^{11} | Ω Ω |
| Safety maximum ratings (maximum permissible in case of fault, see thermal derating curve) Package temperature Current (input current $I_F, P_{si} = 0$) Power (output or total power dissipation) Isolation resistance $V_{IO} = 500 \text{ V dc at } T_A = T_{si}$ | T_{si} I_{si} P_{si} $R_{is \text{ MIN.}}$ | 150 150 600 10^9 | °C mA mW Ω |

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(Note)

(1) "NEC Electronics" as used in this statement means NEC Electronics Corporation and also includes its majority-owned subsidiaries.

(2) "NEC Electronics products" means any product developed or manufactured by or for NEC Electronics (as defined above).

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| <p>Caution GaAs Products</p> | <p>This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.</p> <ul style="list-style-type: none"> • Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below. <ol style="list-style-type: none"> 1. Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials. 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal. • Do not burn, destroy, cut, crush, or chemically dissolve the product. • Do not lick the product or in any way allow it to enter the mouth. |
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